

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6598887

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YOSHIYA YAMADA	02/17/2021
KOJI KIKUCHI	03/08/2021
TOSHIYASU ITO	03/08/2021
YOSUKE TAKAI	03/08/2021
RECEIVING PARTY DATA	
Name:	YAMAICHI ELECTRONICS CO., LTD.
Street Address:	2-16-2 MINAMIKAMATA, OTA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	1448581
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17177833
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NAME OF SUBMITTER:	TODD A. SULLIVAN
SIGNATURE:	/Todd A. Sullivan/
DATE SIGNED:	03/12/2021
Total Attachments: 3	
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source=Try_2101_Assignment#page3.tif	

ASSIGNMENT

We,

Yoshiya YAMADA of c/o Yamaichi Electronics Co., Ltd., 2-16-2 Minamikamata, Ota-ku Tokyo, Japan, 1448581,

Koji KIKUCHI of c/o Yamaichi Electronics Co., Ltd., 2-16-2 Minamikamata, Ota-ku Tokyo, Japan, 1448581,

Toshiyasu ITO of c/o Yamaichi Electronics Co., Ltd., 2-16-2 Minamikamata, Ota-ku Tokyo, Japan, 1448581,

Yosuke TAKAI of c/o Yamaichi Electronics Co., Ltd., 2-16-2 Minamikamata, Ota-ku Tokyo, Japan, 1448581,

having invented certain inventions and improvements and having executed a patent application having the serial numbers CN202010095570.9 filed February 17, 2020, (hereinafter the Priority Applications), now seek to file one or more applications for Letters Patent of the United States of America, which will claim priority to this patent application.

For good valuable consideration, the receipt of which is hereby acknowledged from Yamaichi Electronics Co., Ltd. A corporation, having its principal place of business at 2-16-2 Minamikamata, Ota-ku Tokyo, Japan, 1448581, (hereinafter called the Assignee), we do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to all patent applications filed in the United States of America (including its territories and dependencies) claiming priority to the Priority Application, including any continuations, continuations-in-part, divisional, or reissue applications thereof, a current listing of which is attached hereto as Exhibit A;

And for the same consideration I do also hereby sell, assign, and transfer unto the Assignee, its successors, and assigns all my rights under the International Convention for the Protection of Industrial Property and all other treaties of like purpose in respect of said inventions and any of them and all parts thereof and said application, and I do hereby authorize the Assignee, its successors, and assigns to apply in my name or its or their own name or names for patents and like rights of exclusion on or for said inventions or any of them or any part thereof in all countries claiming if it or they so desire the priority of the filing date of said application under the provisions of said Convention or any such other treaty;

And for the same consideration, I do hereby agree for myself and for my heirs, executors, and administrators, promptly upon request of the Assignee, its successors, or assigns, to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, its successors, or assigns fully to secure to it or

them said right, title, and interest as aforesaid in and to said inventions and any of them and all parts thereof and in and to and under said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And I do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Officer of each country foreign thereto to issue to the Assignee, its successors, or assigns, any and all patents and like rights of exclusion which may be granted in any country upon said United States application or other applications or any of them or on or for said inventions or any of them or any part thereof; and I do hereby covenant for myself and my legal representatives and agree with the Assignee, its successors, and assigns that I have granted no right or license to make, use, or sell said inventions or any of them or any part thereof to anyone except the Assignee, that prior to the execution of this deed my right, title, and interest in and to said inventions or any of them or any part thereof has not been otherwise encumbered by us, and that I have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

17 / 02 / 2021 山田 喜也
Date Yoshiya YAMADA

3/8/2021 Koji Kikuchi
Date Koji KIKUCHI

8/3/2021 T. Ito
Date Toshiyasu ITO

8/3/2021 Yosuke Takai
Date Yosuke TAKAI

Exhibit A

[U.S. Patent Application No. 17/177,833 – Filed: February 17, 2021 – Title: LGA Socket]